**Label Table**

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
</tr>
</thead>
<tbody>
<tr>
<td>001</td>
<td>TIDA-00779 Rev A</td>
</tr>
<tr>
<td>002</td>
<td>TIDA-00779 Rev B</td>
</tr>
</tbody>
</table>

**Assembly Notes**

- **ZZ2** *ESD Sensitive*:
  - These assemblies are ESD sensitive, ESD precautions shall be observed.

- **ZZ3** *Clean and Flux Free*:
  - These assemblies must be clean and free of flux and all contaminants. Use of no clean flux is not acceptable.

- **ZZ4** *Workmanship Class 2*:
  - These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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**Notes**

- You should delete the nylon screws/standoffs and/or the bumpons as needed for your design (or substitute other parts from Hardware.IntLib). Bumpons are cheaper, but provide less clearance.
- Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).
- Update the Label Text in the Label Table as needed for each Assembly Variant.
- You can delete this note too.
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